

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: VS-20TQ040STRL-M3

Manufacturer: Vishay General Semiconductor - Diodes Division

Package: TO-263-3, D2PAK (2 Leads + Tab), TO-263AB

Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/vishay-general-semiconductor-diodes-division-vs-20tq040stl-m3.html>

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New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

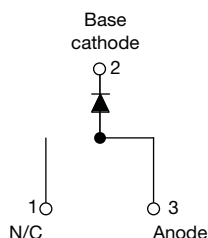
Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

High Performance Schottky Rectifier, 20 A



FEATURES

- 150 °C T_J operation
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
I _{F(AV)}	20 A
V _R	35 V, 40 V, 45 V
V _F at I _F	0.51 V
I _{RM} typ.	105 mA at 125 °C
T _J max.	150 °C
E _{AS}	27 mJ
Package	D ² PAK (TO-263AB)
Circuit configuration	Single

DESCRIPTION

The VS-20TQ... Schottky rectifier series has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MECHANICAL DATA

Case: D²PAK (TO-268AB)

Molding compound meets UL 94-V0 flammability rating

Terminals: matte tin plated leads, solderable per J-STD-002

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
I _{F(AV)}	Rectangular waveform	20	A
V _{RRM}	Range	35 to 45	V
I _{FSM}	t _p = 5 μs sine	1800	A
V _F	20 A _{pk} , T _J = 125 °C	0.51	V
T _J	Range	-55 to +150	°C

VOLTAGE RATINGS					
PARAMETER	SYMBOL	VS-20TQ035S-M3	VS-20TQ040S-M3	VS-20TQ045S-M3	UNITS
Maximum DC reverse voltage	V _R	35	40	45	V
Maximum working peak reverse voltage	V _{RWM}				

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 116 °C, rectangular waveform	20	A
Maximum peak one cycle non-repetitive surge current, see fig. 7	I _{FSM}	5 μs sine or 3 μs rect. pulse	1800	
		10 ms sine or 6 ms rect. pulse	400	
Non-repetitive avalanche energy	E _{AS}	T _J = 25 °C, I _{AS} = 4 A, L = 3.40 mH	27	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μs Frequency limited by T _J maximum V _A = 1.5 x V _R typical	4	A

**ELECTRICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop See fig. 1	$V_{FM}^{(1)}$	20 A	$T_J = 25\text{ }^{\circ}\text{C}$	0.57	V
		40 A		0.73	
		20 A	$T_J = 125\text{ }^{\circ}\text{C}$	0.51	
		40 A		0.67	
Maximum reverse leakage current	$I_{RM}^{(1)}$	$T_J = 25\text{ }^{\circ}\text{C}$	$V_R = \text{Rated } V_R$	2.7	mA
		$T_J = 125\text{ }^{\circ}\text{C}$		150	
Typical reverse leakage current	$I_{RM}^{(1)}$	$T_J = 125\text{ }^{\circ}\text{C}$	$V_R = \text{Rated } V_R$	105	mA
Maximum junction capacitance	C_T	$V_R = 5\text{ V}_{DC}$ (test signal range 100 kHz to 1 MHz), $25\text{ }^{\circ}\text{C}$		1400	pF
Typical series inductance	L_S	Measured lead to lead 5 mm from package body		8.0	nH
Maximum voltage rate of change	dV/dt	Rated V_R		10 000	V/μs

Note

⁽¹⁾ Pulse width < 300 μs , duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-55 to 150	°C
Maximum thermal resistance, junction to case	R _{thJC}	DC operation See fig. 4	1.50	°C/W
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth, and greased	0.50	
Approximate weight			2	g
			0.07	oz.
Mounting torque	minimum		6 (5)	kgf · cm (lbf · in)
	maximum		12 (10)	
Marking device		Case style D ² PAK (TO-263AB)	20TQ035S 20TQ040S 20TQ045S	

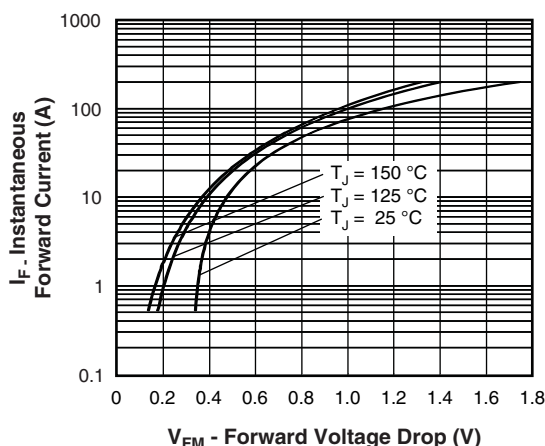


Fig. 1 - Maximum Forward Voltage Drop Characteristics

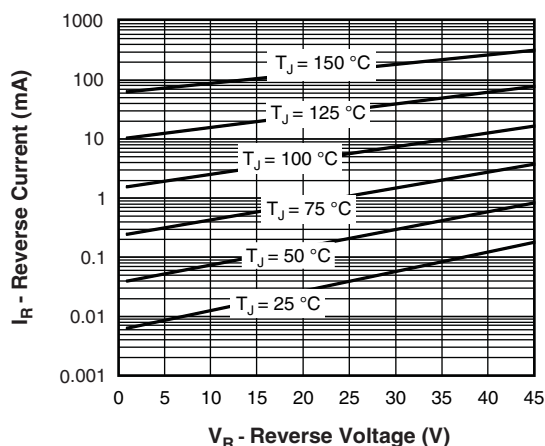


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

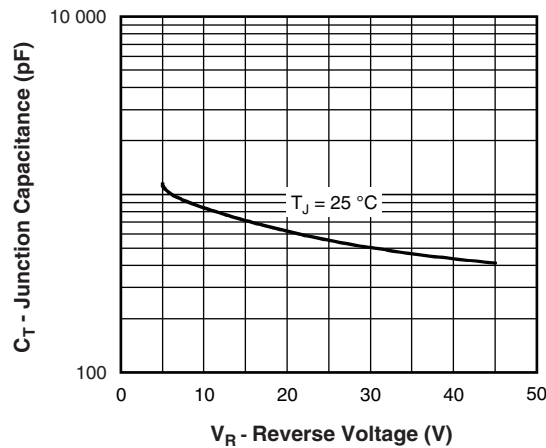


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

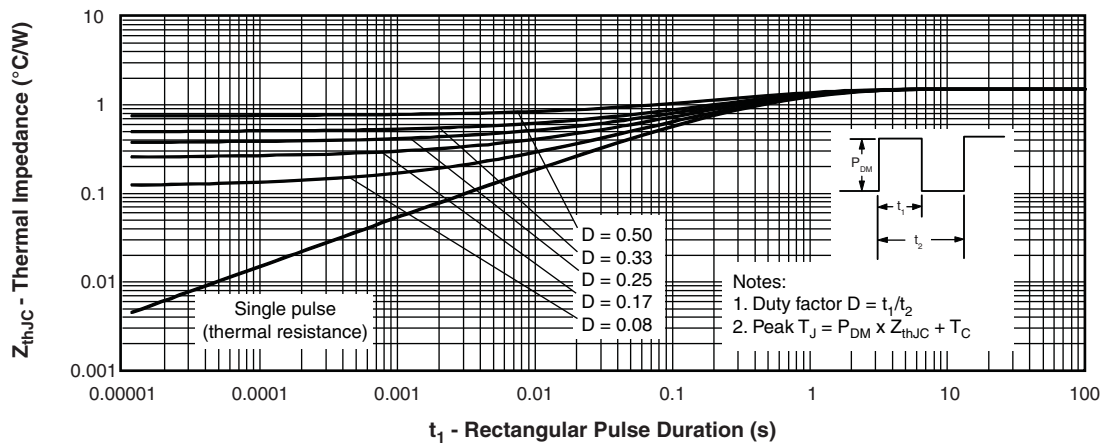
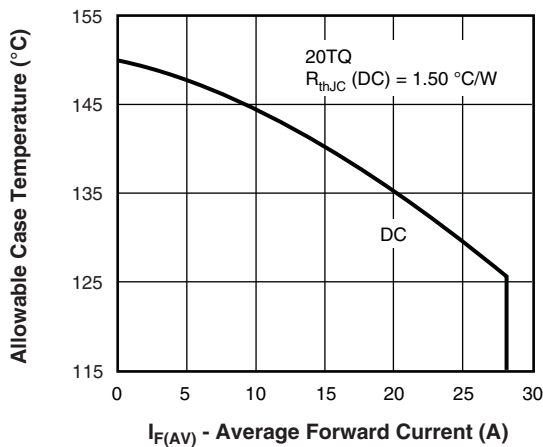

Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

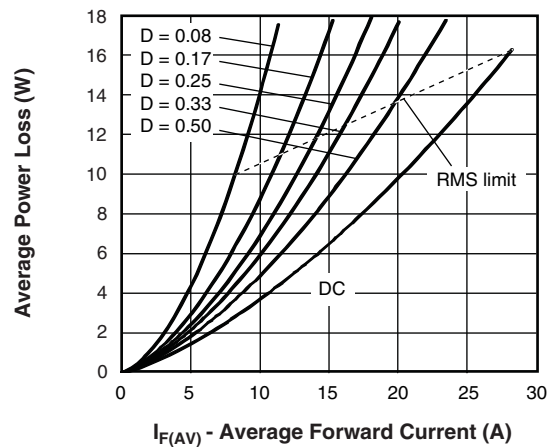


Fig. 6 - Forward Power Loss Characteristics

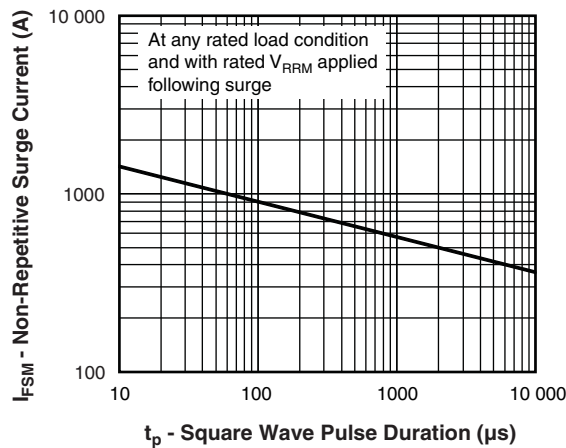


Fig. 7 - Maximum Non-Repetitive Surge Current

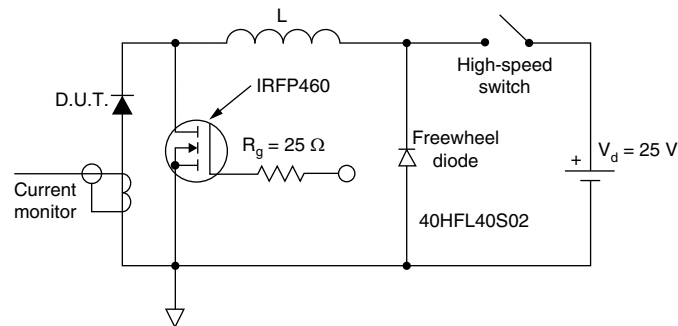


Fig. 8 - Unclamped Inductive Test Circuit

ORDERING INFORMATION TABLE

Device code	VS-	20	T	Q	045	S	TRL	-M3
	1	2	3	4	5	6	7	8
1	Vishay Semiconductors product							
2	Current rating (20 A)							
3	Package: T = TO-220							
4	Schottky "Q" series							
5	Voltage ratings							
6	S = D ² PAK							
7	- None = tube - TRL = tape and reel (left oriented) - TRR = tape and reel (right oriented)							
8	-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free							

**ORDERING INFORMATION**

PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION
VS-20TQ035S-M3	50	Antistatic plastic tubes
VS-20TQ035STRL-M3	800	13" diameter plastic tape and reel
VS-20TQ035STRR-M3	800	13" diameter plastic tape and reel
VS-20TQ040S-M3	50	Antistatic plastic tubes
VS-20TQ040STRL-M3	800	13" diameter plastic tape and reel
VS-20TQ040STRR-M3	800	13" diameter plastic tape and reel
VS-20TQ045S-M3	50	Antistatic plastic tubes
VS-20TQ045STRL-M3	800	13" diameter plastic tape and reel
VS-20TQ045STRR-M3	800	13" diameter plastic tape and reel

LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?96164
Part marking information	www.vishay.com/doc?95444
Packaging information	www.vishay.com/doc?96424
SPICE model	www.vishay.com/doc?96917



D²PAK

DIMENSIONS in millimeters and inches

Conforms to JEDEC® outline D²PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
H	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010 BSC		
L4	4.78	5.28	0.188	0.208	

Notes

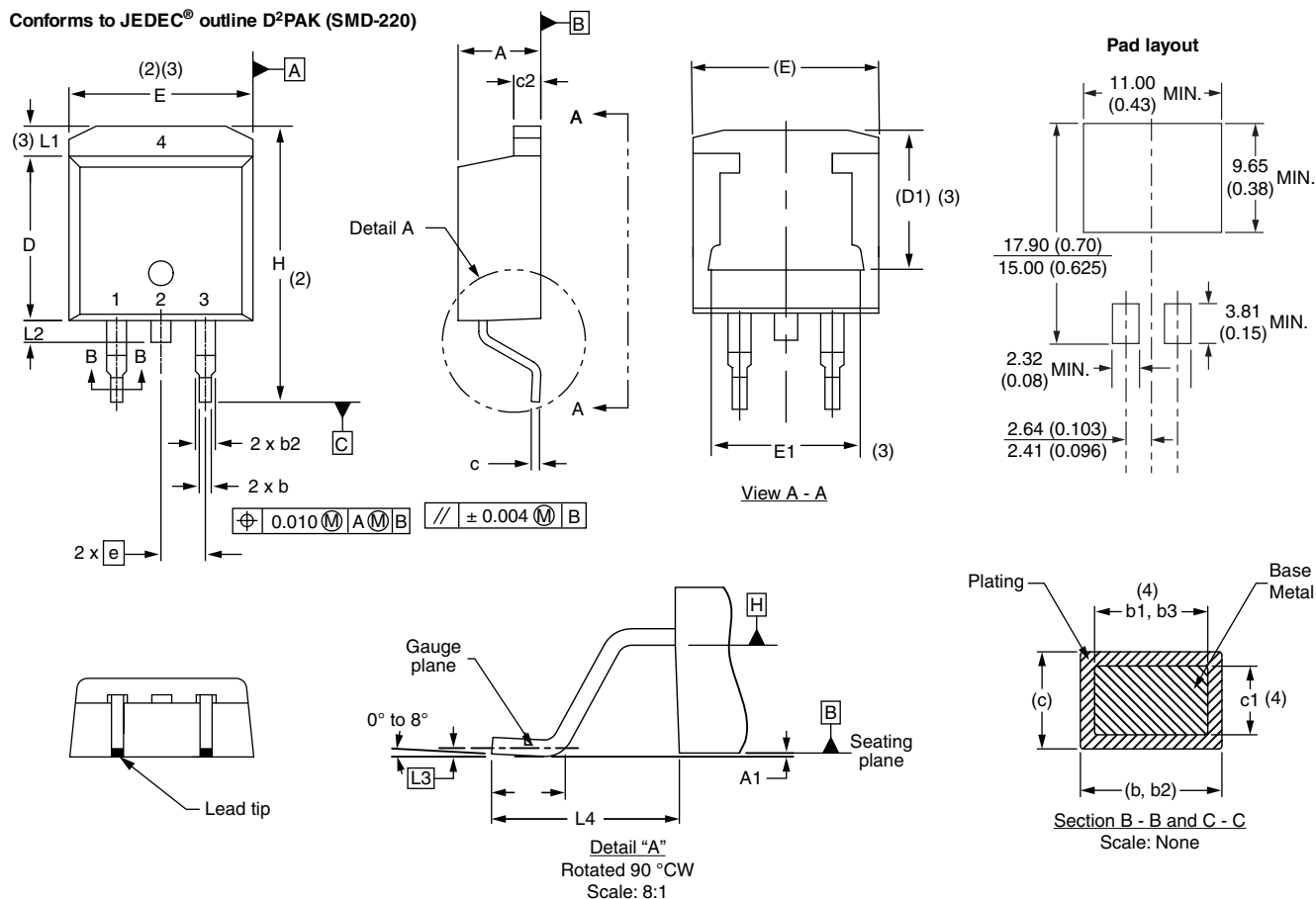
- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



D²PAK

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